Schottky Barrier Diode Silicon Epitaxial

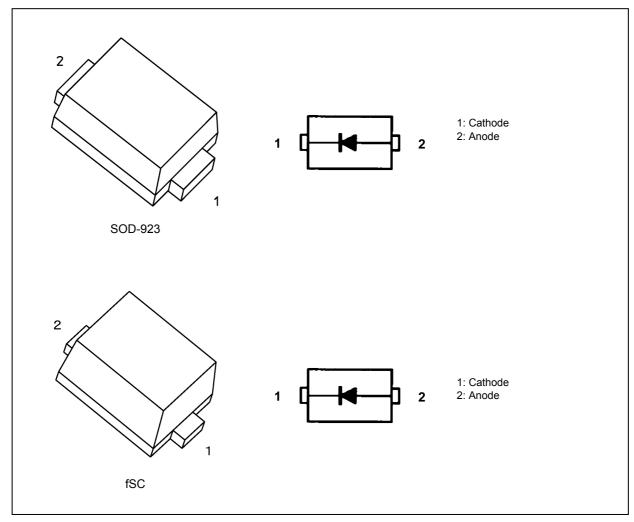
1SS413

1SS413

1. Applications

High-Speed Switching

2. Packaging and Internal Circuit



3. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V _{RM}		25	V
Reverse voltage	V _R		20	
Peak forward current	I _{FM}		100	mA
Average rectified current	I _O		50	mA
Power dissipation	PD	(Note 1)	100	mW
Non-repetitive peak forward surge current	I _{FSM}	(Note 2)	1	А
Junction temperature	Тј		125	°C
Storage temperature	T _{stg}		-55 to 125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on a glass epoxy circuit board of 20 mm \times 20 mm, Pad dimension of 4 mm \times 4 mm.

Note 2: Measured with a 10 ms pulse.

4. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F(1)}	I _F = 1 mA	_	0.33	_	V
Forward voltage	V _{F(2)}	I _F = 5 mA	_	0.38	_	V
Forward voltage	V _{F(3)}	I _F = 50 mA	_	0.50	0.55	V
Reverse current	I _R	V _R = 20 V	_	_	0.5	μA
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	_	3.9	_	pF

5. Marking

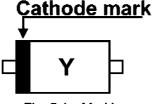


Fig. 5.1 Marking

6. Usage Considerations

• Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.

7. Land Pattern Dimensions (for reference only)

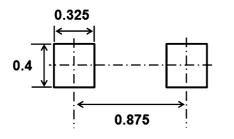


Fig. 7.1 SOD-923 (Unit: mm)

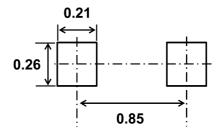
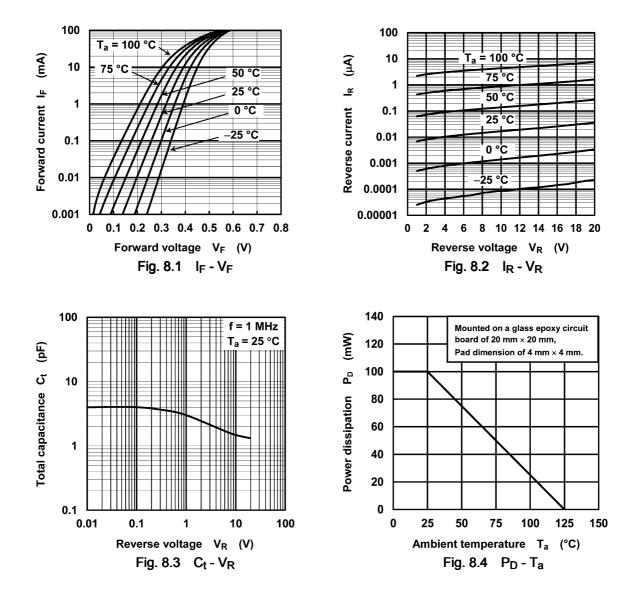


Fig. 7.2 fSC (Unit: mm)

8. Characteristics Curves (Note)



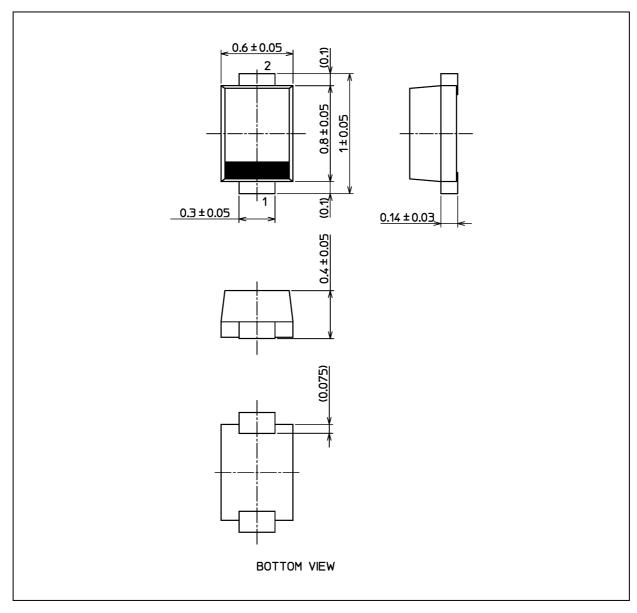
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

1SS413

Unit: mm



Weight: 0.55 mg (typ.)

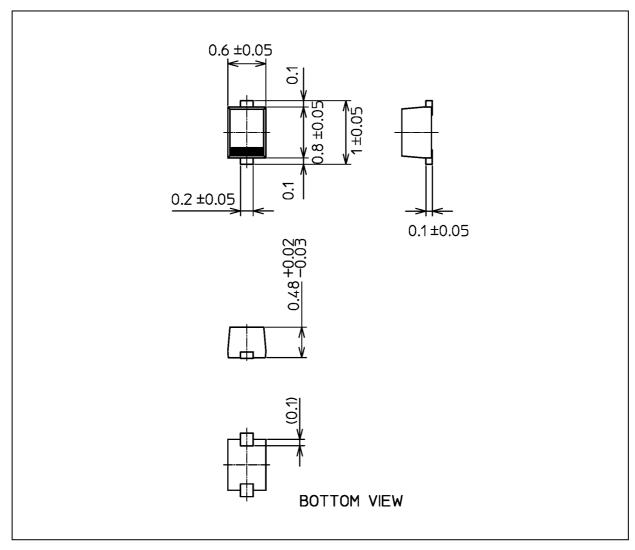
Packag	e Name(s)
TOSHIBA: 1-1AH1A	
Nickname: SOD-923	



Package Dimensions

1SS413





Weight: 0.6 mg (typ.)

	Package Name(s)	
TOSHIBA: 1-1L1S		
Nickname: fSC		

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